COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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<th>GENERATED : 9/12/2017 5:22:08 PM</th>
<th>TEXAS INSTRUMENTS</th>
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COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP21098 | REV: A | SUN REV: Not In VersionControl
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| TID #: N/A
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PLOT NAME = Bottom Assembly Drawing | GENERATED : 9/12/2017 5:22:11 PM | TEXAS INSTRUMENTS
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